SCAS325A - JULY 1990 - REVISED NOVEMBER 1995

- Replaces SN74AS304
- Maximum Output Skew of 1 ns
- Maximum Pulse Skew of 1.5 ns
- TTL-Compatible Inputs and Outputs
- Center-Pin V<sub>CC</sub> and GND Configurations Minimize High-Speed Switching Noise
- Package Options Include Plastic Small-Outline (D) Package and Standard Plastic (N) 300-mil DIPs

#### **DORNPACKAGE** (TOP VIEW) Q3 16 🛮 Q2 15 Q1 Q4 [ GND 3 14 CLR GND II 13 V<sub>CC</sub> GND 5 12 J ∨<sub>CC</sub> 6 CLK Q5 L 11 Q6 🛮 7 PRE 9 Q7 8 J Q8

## description

The CDC304 contains eight flip-flops designed to have <u>low skew between outputs</u>. The eight outputs (in-phase with CLK) toggle on successive CLK pulses. Preset (PRE) and clear (CLR) inputs are provided to set the Q outputs high or low independent of the clock (CLK) input.

The CDC304 has output and pulse-skew parameters  $t_{sk(0)}$  and  $t_{sk(p)}$  to ensure performance as a clock driver when a divide-by-two function is required.

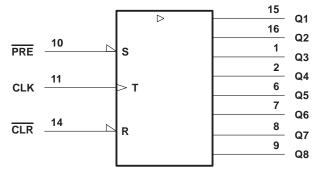
The CDC304 is characterized for operation from 0°C to 70°C.

### **FUNCTION TABLE**

	INPUTS	OUTPUTS			
CLR	PRE	CLK	Q1-Q8		
L	Н	Х	L		
Н	L	X	Н		
L	L	X	L†		
Н	Н	$\uparrow$	$\overline{\mathtt{Q}}_0$		
Н	Н	L	$Q_0$		

<sup>†</sup>This configuration does not persist when PRE or CLR returns to its inactive (high) level.

# logic symbol‡



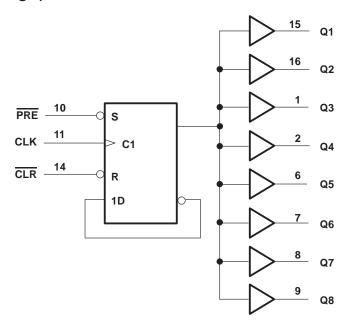
<sup>&</sup>lt;sup>‡</sup>This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub>	7 V
Input voltage, V <sub>I</sub>	7 V
Maximum power dissipation at T <sub>A</sub> = 55°C (in still air) (see Note 1): D package	0.77 W
N package	1.2 W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 300 mils, except for the N package, which has a trace length of zero. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

## recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
$V_{IH}$	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage			0.8	V
ЮН	High-level output current			-24	mA
loL	Low-level output current			48	mA
fclock	Input clock frequency			80	MHz
TA	Operating free-air temperature	0		70	°C



SCAS325A - JULY 1990 - REVISED NOVEMBER 1995

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	1	TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
VIK	$V_{CC} = 4.5 \text{ V},$	$I_I = -18 \text{ mA}$			-1.2	V
Man.	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V <sub>CC</sub> -2			V
VOH	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -24 \text{ mA}$	2	2.8		V
VOL	$V_{CC} = 4.5 \text{ V},$	$I_{OL} = 48 \text{ mA}$		0.3	0.5	V
lį	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 7 V			0.1	mA
lн	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 2.7 V			20	μΑ
Ι <sub>Ι</sub> L	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 0.4 V			-0.5	mA
lo <sup>‡</sup>	$V_{CC} = 5.5 \text{ V},$	$V_0 = 2.25 \text{ V}$	-50		-150	mA
lcc	V <sub>CC</sub> = 5.5 V,	See Note 2		45	75	mA

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

## timing requirements

			MIN	MAX	UNIT
fclock	Clock frequency			80	MHz
t <sub>W</sub>		CLR or PRE low	5		
	Pulse duration	CLK high	4		ns
		CLK low	6		
t <sub>su</sub>	Setup time before CLK↑	CLR or PRE inactive	6		ns

# switching characteristics over recommended operating free-air temperature range (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
f <sub>max</sub> §				80			MHz	
<sup>t</sup> PLH	CLK	Q	P 500 O. C 50 pE	2	6	9	ns	
tPHL	CLK	ď	$R_L = 500 \Omega$ , $C_L = 50 pF$	2	6	9		
<sup>t</sup> PLH	PRE or CLR	Q	$R_L = 500 \Omega$ , $C_L = 50 pF$	3	7	12	ns	
t <sub>PHL</sub>		g	KL = 300 sz, GL = 30 pr	3	7	12	110	
tsk(o)	CLK	Q	$R_L = 500 \Omega$ , $C_L = 10 pF to 30 pF$ , See Figure 2			1	ns	
* * * * *	CLK	CLK (	Q1, Q8	D. 500 O. C. 10 pE to 20 pE			1	no
<sup>t</sup> sk(p)		Q2-Q7	$R_L = 500 \Omega$ , $C_L = 10 pF to 30 pF$			1.5	ns	
t <sub>r</sub>						4.5	ns	
t <sub>f</sub>						3.5	ns	

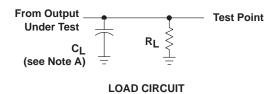
<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

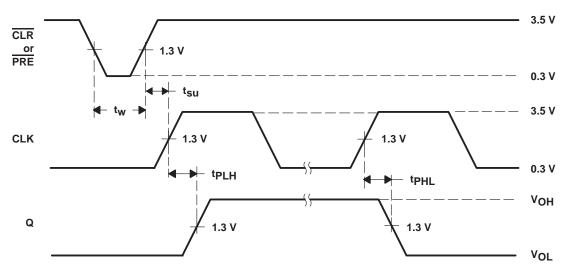


<sup>&</sup>lt;sup>‡</sup>The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I<sub>OS</sub>. NOTE 2: I<sub>CC</sub> is measured with CLK and PRE grounded, then with CLK and CLR grounded.

<sup>§</sup> f<sub>max</sub> minimum values are at C<sub>L</sub> = 0 to 30 pF.

### PARAMETER MEASUREMENT INFORMATION





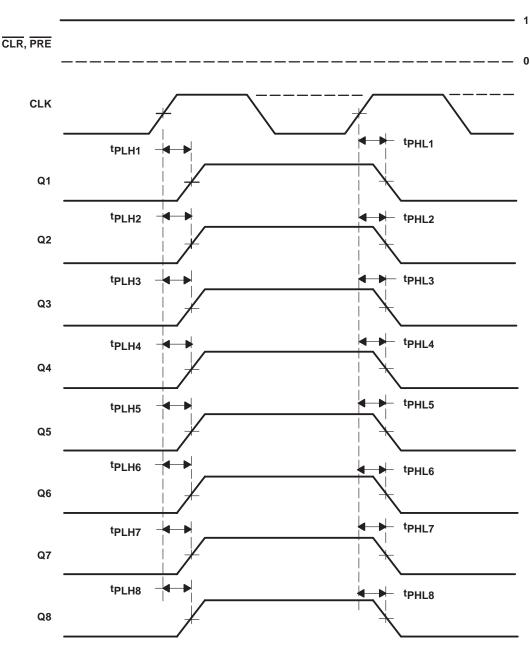
NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

B. Input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $t_r = 2.5$  ns,  $t_f = 2.5$  ns.

Figure 1. Load Circuit and Voltage Waveforms



### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $t_{sk(0)}$ , CLK to Q, is calculated as the greater of the following:

- The difference between the fastest and slowest of tp<sub>LHn</sub> (n = 1, 2, 3 . . ., 8)
  The difference between the fastest and slowest of tp<sub>HLn</sub> (n = 1, 2, 3 . . ., 8)
- B.  $t_{Sk(p)}$  is defined at the greater of  $|t_{PLHn} t_{PHLn}|$  ( n = 1, 2, 3, ..., 8 ).

Figure 2. Waveforms for Calculation of  $t_{sk(0)}$  and  $t_{sk(p)}$ 

### **IMPORTANT NOTICE**

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 1998, Texas Instruments Incorporated